Electronic Patent Application Fee Transmittal								
Application Number:	10711503							
Filing Date:	22-Sep-2004							
Title of Invention:	IC PACKAGE HAVING GROUND IC CHIP AND METHOD OF MANUFACTURING SAME							
First Named Inventor/Applicant Name:	PEI-HAW TSAO							
Filer:	James H. Ortega/Angela Young							
Attorney Docket Number:	TSMC 2003-1622							
Filed as Large Entity								
Utility Filing Fees								
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)			
Basic Filing:								
Pages:								
Claims:								
Miscellaneous-Filing:								
Petition:								
Patent-Appeals-and-Interference:								
Post-Allowance-and-Post-Issuance:								
Extension-of-Time:								

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)	
Miscellaneous:					
Request for continued examination	1801	1	790	790	
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